## HEXFRED ${ }^{\circledR}$ <br> Ultrafast Soft Recovery Diode, 240 A



TO-244


| PRODUCT SUMMARY |  |
| :---: | :---: |
| $\mathrm{I}_{\mathrm{F}(\mathrm{AV})}$ | 240 A |
| $\mathrm{~V}_{\mathrm{R}}$ | 400 V |
| $\mathrm{I}_{\mathrm{F}(\mathrm{DC})}$ at $\mathrm{T}_{\mathrm{C}}$ | 197 A at $100^{\circ} \mathrm{C}$ |

FEATURES

- Very low $Q_{r r}$ and $t_{r r}$
- Lead (Pb)-free
- Designed and qualified for industrial level

RoHS COMPLIANT

## BENEFITS

- Reduced RFI and EMI
- Reduced snubbing


## DESCRIPTION

HEXFRED ${ }^{\circledR}$ diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dl/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

| ABSOLUTE MAXIMUM RATINGS |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS |
| Cathode to anode voltage | $\mathrm{V}_{\mathrm{R}}$ |  | 400 | V |
| Continuous forward current | $\mathrm{I}_{\mathrm{F}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 395 | A |
|  |  | $\mathrm{T}_{\mathrm{C}}=10{ }^{\circ} \mathrm{C}$ | 197 |  |
| Single pulse forward current | $\mathrm{I}_{\text {FSM }}$ | Limited by junction temperature | 900 |  |
| Non-repetitive avalanche energy | $\mathrm{E}_{\text {AS }}$ | $\mathrm{L}=100 \mu \mathrm{H}$, duty cycle limited by maximum $\mathrm{T}_{J}$ | 1.4 | mJ |
| Maximum power dissipation | $\mathrm{P}_{\mathrm{D}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 658 | W |
|  |  | $\mathrm{T}_{\mathrm{C}}=10{ }^{\circ} \mathrm{C}$ | 263 |  |
| Operating junction and storage temperature range | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {Stg }}$ |  | - 55 to + 150 | ${ }^{\circ} \mathrm{C}$ |

ELECTRICAL SPECIFICATIONS $\left(\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)


| DYNAMIC RECOVERY CHARACTERISTICS ( $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ unless otherwise specified) |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | TEST CONDITIONS |  | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time See fig. 5 | $\mathrm{trrr}_{\text {r }}$ | $\mathrm{I}_{\mathrm{F}}=1.0 \mathrm{~A}, \mathrm{dl}_{\mathrm{F}} / \mathrm{dt}=200 \mathrm{~A} / \mu \mathrm{s}, \mathrm{V}_{\mathrm{R}}=30 \mathrm{~V}$ |  | - | 50 | - | ns |
|  |  | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=140 \mathrm{~A} \\ & \mathrm{dI}_{\mathrm{F}} / \mathrm{dt}=200 \mathrm{~A} / \mu \mathrm{s} \\ & \mathrm{~V}_{\mathrm{R}}=200 \mathrm{~V} \end{aligned}$ | - | 77 | 120 |  |
|  |  | $\mathrm{T}_{J}=125^{\circ} \mathrm{C}$ |  | - | 290 | 440 |  |
| Peak recovery current See fig. 6 | $I_{\text {RRM }}$ | $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ |  | - | 7.5 | 14 | A |
|  |  | $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  | - | 16 | 30 |  |
| Reverse recovery charge See fig. 7 | $\mathrm{Q}_{\mathrm{rr}}$ | $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ |  | - | 290 | 780 | nC |
|  |  | $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  | - | 2300 | 6300 |  |
| Peak rate of recovery current See fig. 8 | $\mathrm{dl}_{(\text {rec) })} / \mathrm{dt}$ | $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ |  | - | 320 | - | A/ $/ \mathrm{s}$ |
|  |  | $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  | - | 270 | - |  |

## THERMAL - MECHANICAL SPECIFICATIONS

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum junction and storage temperature range | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {Stg }}$ | -55 | - | 150 | ${ }^{\circ} \mathrm{C}$ |
| Thermal resistance, junction to case $\quad$ per leg | $\mathrm{R}_{\text {thJc }}$ | - | - | 0.19 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | - | - | 0.095 |  |
| Typical thermal resistance, case to heatsink | $\mathrm{R}_{\mathrm{th} \mathrm{CS}}$ | - | 0.10 | - |  |
| Weight |  | - | 68 | - | g |
|  |  | - | 2.4 | - | oz. |
| Mounting torque $\quad$ cric ${ }^{\text {(1) }}$ |  | 30 (3.4) | - | 40 (4.6) | $\begin{gathered} \mathrm{N} \cdot \mathrm{~m} \\ (\mathrm{lbf} \cdot \mathrm{in}) \end{gathered}$ |
|  |  | 12 (1.4) | - | 18 (2.1) |  |
|  |  | 30 (3.4) | - | 40 (4.6) |  |
| Vertical pull |  | - | - | 80 | lbf $\cdot$ in |
| 2" lever pull |  | - | - | 35 |  |

## Note

(1) Mounting surface must be smooth, flat, free of burrs or other protrusions. Apply a thin even film or thermal grease to mounting surface. Gradually tighten each mounting bolt in 5 to $10 \mathrm{lbf} \cdot$ in steps until desired or maximum torque limits are reached.


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current (Per Leg)


Fig. 2 - Typical Reverse Current vs. Reverse Voltage (Per Leg)


Fig. 3-Typical Junction Capacitance vs. Reverse Voltage (Per Leg)


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current (Per Leg)


Fig. 5 - Typical Reverse Recovery Time vs. $\mathrm{dl}_{\mathrm{F}} / \mathrm{dt}$ (Per Leg)


Fig. 6 - Typical Recovery Current vs. $\mathrm{dl}_{\mathrm{F}} / \mathrm{dt}$ (Per Leg)


Fig. 7 - Typical Stored Charge vs. $\mathrm{dl}_{\mathrm{F}} / \mathrm{dt}$ (Per Leg)


Fig. 8 - Typical $\mathrm{dl}_{(\text {rec }) \mathrm{M}} / \mathrm{dt}$ vs. $\mathrm{dl}_{\mathrm{F}} / \mathrm{dt}$ (Per Leg)


Fig. 9 - Maximum Thermal Impedance $\mathrm{Z}_{\text {thJc }}$ Characteristics (Per Leg)


Fig. 10 - Reverse Recovery Parameter Test Circuit

(1) $\mathrm{dl}_{\mathrm{F}} / \mathrm{dt}$
(1) $\mathrm{dl}_{\mathrm{F}} / \mathrm{dt}$ - rate of change of current through zero crossing
(2) $I_{\text {RRM }}$ - peak reverse recovery current
(3) $t_{r r}$ - reverse recovery time measured from zero crossing point of negative going $I_{F}$ to point where a line passing through $0.75 \mathrm{I}_{\text {RRM }}$ and $0.50 \mathrm{I}_{\text {RRM }}$ extrapolated to zero current.
(4) $Q_{r r}$ - area under curve defined by $t_{r r}$ and $I_{\text {RRM }}$

$$
Q_{r r}=\frac{t_{r r} \times I_{R R M}}{2}
$$

(5) $\mathrm{dl}_{(\text {rec) }} / \mathrm{dt}$ - peak rate of change of current during $t_{b}$ portion of $t_{r r}$

Fig. 11 - Reverse Recovery Waveform and Definitions


Fig. 12 - Avalanche Test Circuit and Waveforms

## ORDERING INFORMATION TABLE



| $\mathbf{1}$ | $-\quad$ HEXFRED |
| :--- | :--- | :--- |${ }^{\circledR}$ family, electron irradiated


| LINKS TO RELATED DOCUMENTS |  |
| :--- | :---: |
| Dimensions | http://www.vishay.com/doc?95021 |

DIMENSIONS in millimeters (inches)


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